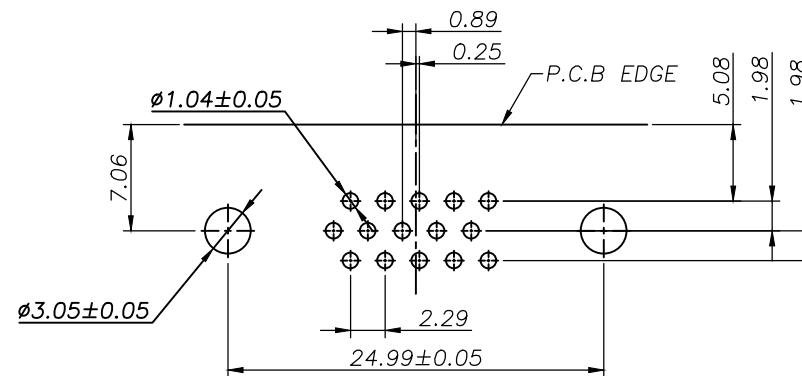
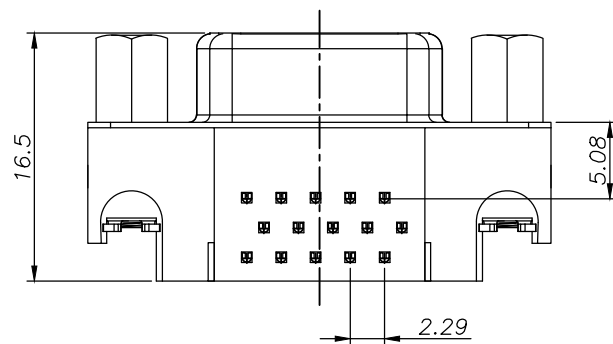
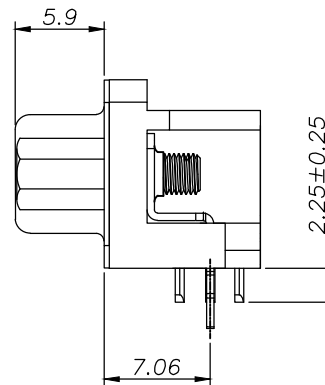
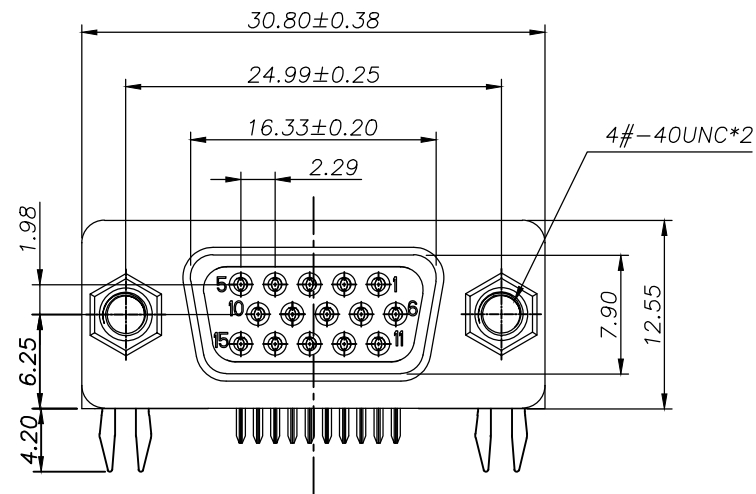


REV.	ECN NO.	DESCRIPTION	DATE	DESIGN
B	---	ADD LAYOUT	2018.12.20	P.J.F
C	---	ADD DRAWINGS	2019.2.26	P.J.F



1. MATERIAL:

INSULATOR : SEE TABLES .
TERMINAL : BRASS, GOLD FLASH ON CONTACT AREA ,
TIN PLATED ON SOLDER TAIL UNDER PLATED NICKEL
SHELL: SPCC, NICKEL PLATING
BRARD LOCK: SPCC, TIN PLATING
SCREW: SPCC, NICKEL PLATING

2. MECHANICAL PERFORMANCE,

INSERTION FORCE: 4.54kgf MAX
REMOVAL FORCE: 0.34kgf MIN
DURABILITY: 500 CYCLES.

3. SPECIFICATION:

CURRENT RATING : 2 AMP
DIELECTRIC WITHSTANDING VOLTAGE : 1000V PER MINUTE .
INSULATION RESISTANCE : 1000MΩ MIN. AT 500V DC.
CONTACT RESISTANCE : 30mΩ MAX.
OPERATING TEMPERATURE : -55° C ~ +105° C.

4. HF COMPLIANT.

5. WAVE SOLDER:

THE CONNECTOR SHALL BE MOUNTED ON THE PCB. THE
TEMPERATURE OF THE SOLDER SHALL BE 260±5 ° C AND
IMMERSION DURATION 10 SECONDS.

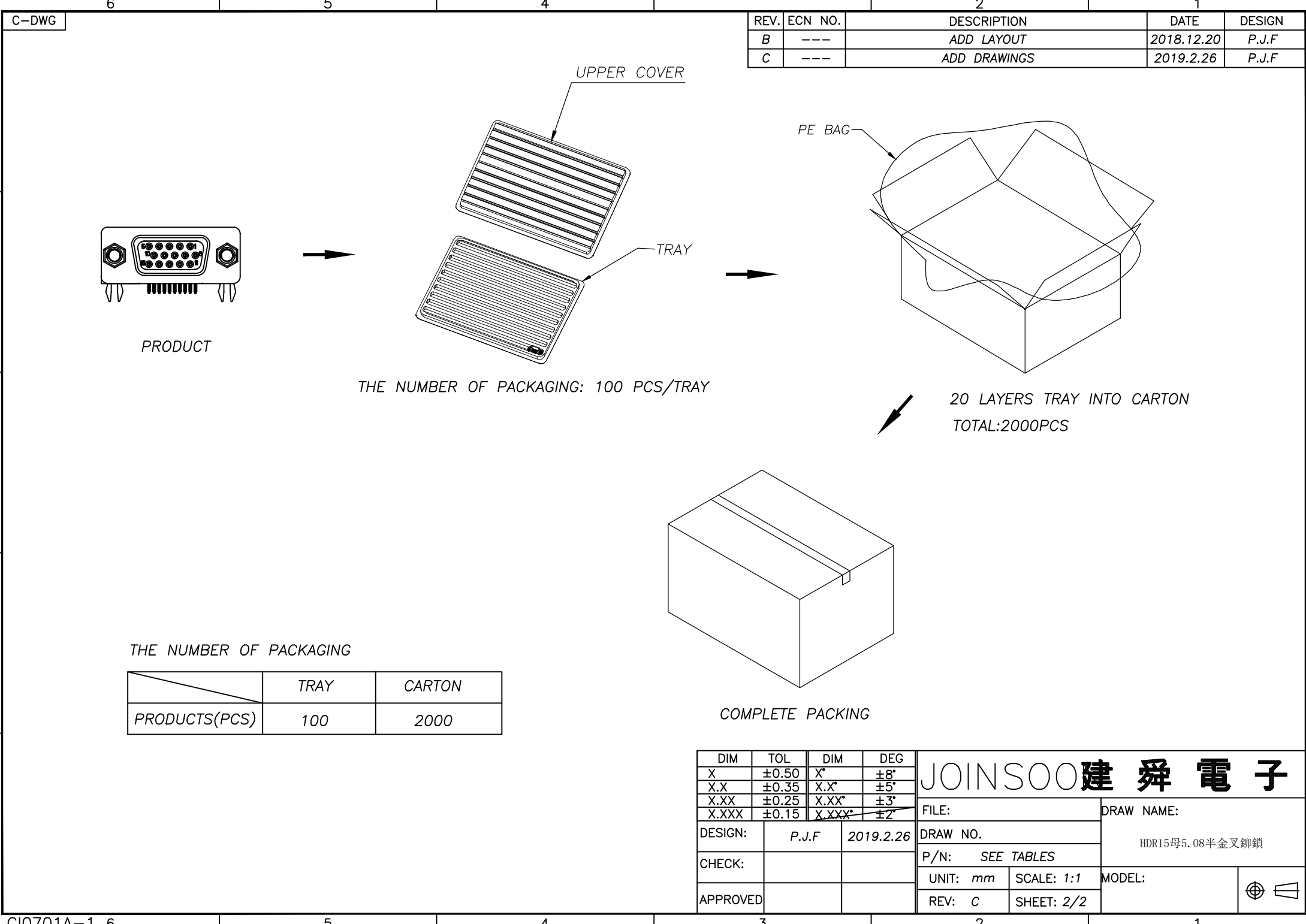
SEE TABLES

ITEM	P/N	DESCRIPTION
1	121D-SADT-081T	INSULATOR:LCP (UL 94V-0) BLACK
2	121D-SADT-091T	INSULATOR:LCP (UL 94V-0) BLUE

DIM	TOL	DIM	DEG
X	±0.50	X°	±8°
X.X	±0.35	X.X°	±5°
X.XX	±0.25	X.XX°	±3°
X.XXX	±0.15	X.XXX°	±2°
DESIGN:	P.J.F	2019.2.26	
CHECK:			
APPROVED			

JOINSOO建舜電子

FILE:	DRAW NAME:
DRAW NO.	HDR15母5.08半金叉鉚鎖
P/N: SEE TABLES	
UNIT: mm	SCALE: 1:1
REV: C	SHEET: 1/2



REV.	ECN NO.	DESCRIPTION	DATE	DESIGN
B	---	ADD LAYOUT	2018.12.20	P.J.F
C	---	ADD DRAWINGS	2019.2.26	P.J.F

THE NUMBER OF PACKAGING

	TRAY	CARTON
PRODUCTS(PCS)	100	2000

COMPLETE PACKING

DIM	TOL	DIM	DEG	JOINSOO建舜電子			
X	±0.50	X°	±8°	DRAW NAME: HDR15母5.08半金叉鉚鎖			
X.X	±0.35	X.X°	±5°				
X.XX	±0.25	X.XX°	±3°	MODEL:			
X.XXX	±0.15	X.XXX°	±2°				
DESIGN:	P.J.F	2019.2.26	DRAW NO.		REV: C		
CHECK:			P/N: SEE TABLES				
APPROVED			UNIT: mm	SCALE: 1:1	SHEET: 2/2		
			REV: C	SHEET: 2/2			